

2MBI1400VXB-120E-54

IGBT Modules

IGBT MODULE (V series) 1200V / 1400A / 2 in one package

Features

High speed switching Voltage drive Low Inductance module structure

Applications

Inverter for Motor Drive AC and DC Servo Drive Amplifier Uninterruptible Power Supply Industrial machines, such as Welding machines



■ Maximum Ratings and Characteristics

Absolute Maximum Ratings (at Tc=25°C unless otherwise specified)

Items	Symbols	Conditions		Maximum ratings	Units
Collector-Emitter voltage	Vces			1200	V
Gate-Emitter voltage	V _{GES}			±20	V
_	1	Continuous	Tc=25°C	1800	
ž	lc lc	Continuous	Tc=100°C	1400	
S Collector current	Ic pulse	1ms		2800	Α
드	-I _c			1400	
	-Ic pulse	1ms		2800	
Collector power dissipation	Pc	1 device		7650	W
Junction temperature	Tj			175	
Operating junction temperature (under switching	conditions) T _{jop}			150	°C
Case temperature	Tc			150	C
Storage temperature	T _{stg}			-40 ~ +150	
Isolation voltage between terminal and coppe		AC : 1min.		4000	VAC
between thermistor and other	ers (*2)	AC . IIIIII.		4000	VAC
Mounting		M5		6.0	
Screw torque (*3) Main Terminals - M8			10.0	N m	
Sense Terminals		M4		2.1	

Note *1: All terminals should be connected together during the test.

Note *2: Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

Note *3: Recommendable Value: Mounting 3.0 ~ 6.0 Nm (M5) Recommendable Value: Main Terminals 8.0 ~ 10.0 Nm (M8)

Recommendable Value: Sense Terminals 1.8 ~ 2.1 Nm (M4)

■ Electrical characteristics (at Tj= 25°C unless otherwise specified)

	Cumbala	Conditions	Characteristics		Haita		
ms	Symbols	Conditions	min.	typ.	max.	Units	
Zero gate voltage collector current	Ices	V _{GE} = 0V, V _{CE} = 1200V		-	-	12.0	mA
Gate-Emitter leakage current	Iges	$V_{CE} = 0V, V_{GE} = \pm 20V$		-	-	2400	nA
Gate-Emitter threshold voltage	V _{GE (th)}	V _{CE} = 20V, I _C = 1400mA		6.0	6.5	7.0	V
	V _{CE} (sat)		T _j =25°C	-	1.85	2.30	- - -
	(terminal)		T _j =125°C	-	2.15	-	
Callantan Emittan anti-matian waltana	(*4)	V _{GE} = 15V	T _j =150°C	-	2.20	-	
Collector-Emitter saturation voltage		Ic = 1400A	T _j =25°C	-	1.75	2.20	
	V _{CE} (sat)		T _j =125°C	-	2.05	-	
	(chip)		T _j =150°C	-	2.10	-	
Internal gate resistance	Rg(int)	-		-	0.79	-	Ω
Input capacitance	Cies	V _{CE} = 10V, V _{GE} = 0V, f = 1	MHz	-	128	-	nF
Input capacitance Turn-on time	ton		-	1000	-	nsec	
	tr	1, 200, 1, 1400, 1, 145, 1		-	400		-
	tr (i)	Vcc=600V, Ic=1400A, VGE	-	150	-		
T (C.C.	toff	R _G =1Ω, Ls=60nH		-	1200		-
Turn-off time	tf		-	150	-		
	V _F		T _i =25°C	-	1.90	2.35	
	(terminal)		T _i =125°C	-	2.05	-	1
	(*4)	$V_{GF} = 0V$	T _i =150°C	-	2.00	-	٠,,
Forward on voltage		I _F = 1400A	T _i =25°C	-	1.80	2.25	V
	V _F		T _i =125°C	-	1.95	-	
	(chip)		T _i =150°C	-	1.90	-	
Reverse recovery time	trr	I _F = 1400A		-	200	-	nsec
	Б	T=25°C		-	5000	-	
Resistance	R	T=100°C		465 495		520	Ω
B value	В	T=25/50°C		3305	3375	3450	K

Note *4: Please refer to page 6, there is definition of on-state voltage at terminal.

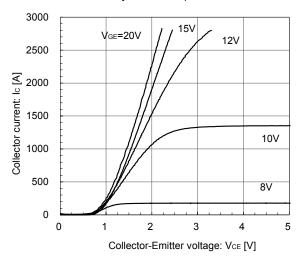
Thermal resistance characteristics

Items	Symbols	Conditions Characteristics			ics	Units
	Syllibols	Conditions	min.	typ.	max.	Units
Thermal registeres (4 device)	Dth/i o)	Inverter IGBT	-	-	0.0195	
Thermal resistance (1device)	Rth(j-c)	Inverter FWD	-	-	0.0360	°C/W
Contact thermal resistance (1device) (*5)	Rth(c-f)	with Thermal Compound	-	0.00420	-	

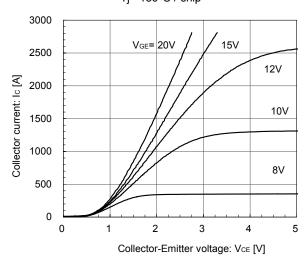
■ Characteristics (Representative)

[INVERTER]

Collector current vs. Collector-Emitter voltage (typ.) Tj= 25°C / chip

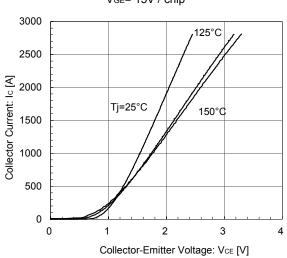


[INVERTER]
Collector current vs. Collector-Emitter voltage (typ.)
Tj= 150°C / chip

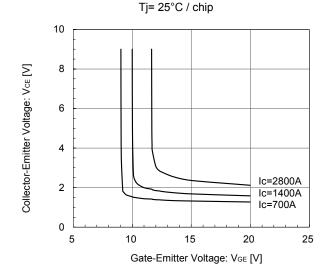


[INVERTER]

Collector current vs. Collector-Emitter voltage (typ.) VgE= 15V / chip

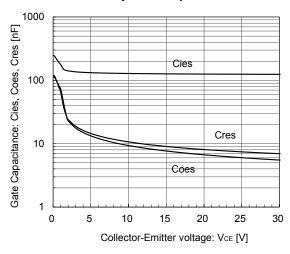


[INVERTER]
Collector-Emitter voltage vs. Gate-Emitter voltage (typ.)



[INVERTER]

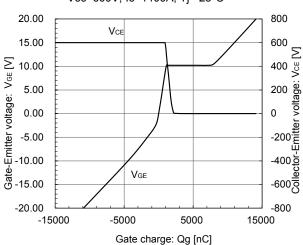
Gate Capacitance vs. Collector-Emitter Voltage (typ.) V_{GE}= 0V, f= 1MHz, Tj= 25°C



[INVERTER]

Dynamic Gate Charge (typ.)

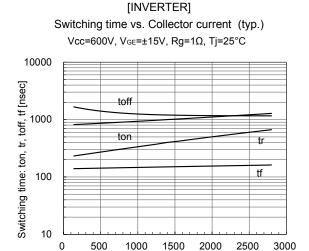
Vcc=600V, Ic=1400A, Tj= 25°C



tf

2500

3000



Switching time vs. Collector current (typ.) Vcc=600V, VgE=±15V, Rg=1Ω, Tj=125°C, 150°C 10000 Switching time: ton, tr, toff, tf [nsec] toff 1000

Tj=125°C Tj=150°C

2000

1500

Collector current: Ic [A]

100

10

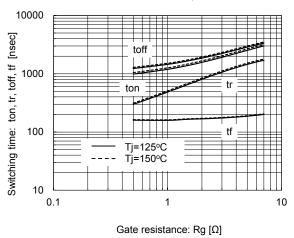
0

500

[INVERTER]

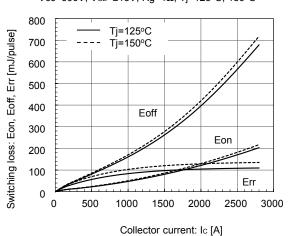
Collector current: Ic [A]

[INVERTER] Switching time vs. Gate resistance (typ.) Vcc=600V, Ic=1400A, VgE=±15V, Tj=125°C, 150°C

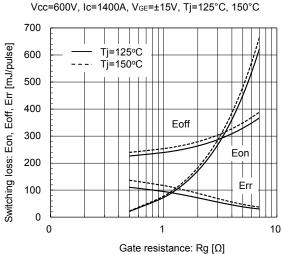


[INVERTER] Switching loss vs. Collector current (typ.) Vcc=600V, V_{GE}= \pm 15V, Rg=1 Ω , Tj=125°C, 150°C

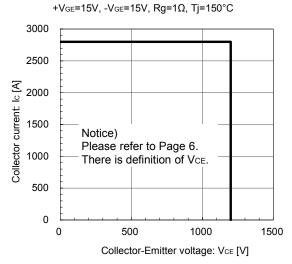
1000



[INVERTER] Switching loss vs. Gate resistance (typ.) Vcc=600V, Ic=1400A, VGE=±15V, Tj=125°C, 150°C



[INVERTER] Reverse bias safe operating area (max.)

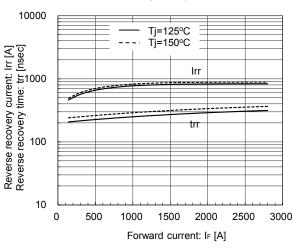


[INVERTER] Forward Current vs. Forward Voltage (typ.) chip 3000 2500 Forward current: IF [A] Tj=25°C 2000 1500 1000 150°C 500 125°C 0 0 3

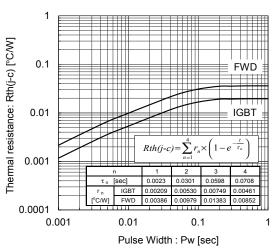
[INVERTER]

[INVERTER]
Reverse Recovery Characteristics (typ.)
Vcc=600V, VgE=±15V, Rg=1Ω, Tj=125°C, 150°C

Forward on voltage: VF [V]

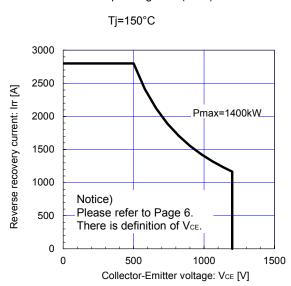


Transient Thermal Resistance (max.)

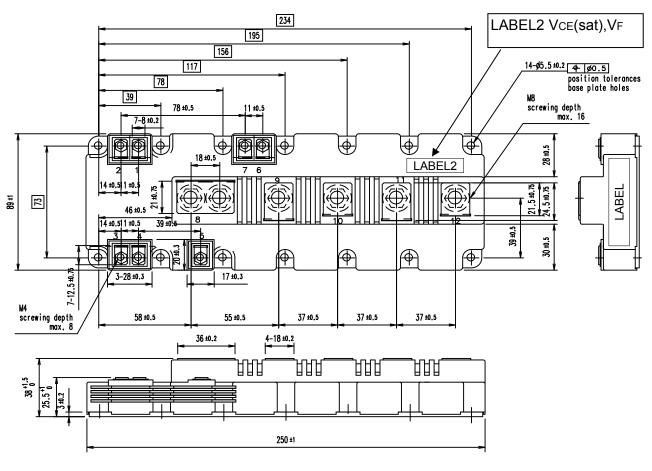


[THERMISTOR]

FWD safe operating area (max.)

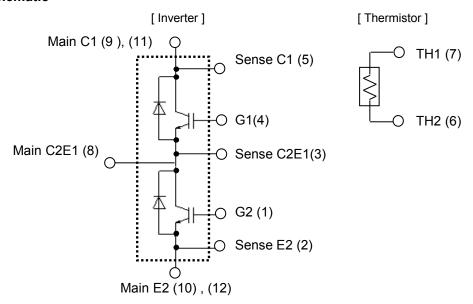


■ Outline Drawings, mm



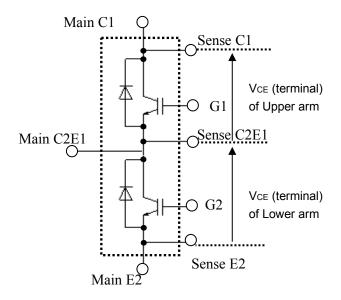
Weight:1250g(typ.)

■ Equivalent Circuit Schematic



http://www.fujielectric.com/products/semiconductor/

■ Definition of on-state voltage at terminal and switching characteristics



Fuji defined V_{CE} value of terminal by using Sense C1 and Sense C2E1 for Upper arm and Sense C2E1 and Sense E2 for Lower arm .

Switching characteristics of V_{CE} also is defined between Sense C1 and Sense C2E1 for Upper arm and Sense C2E1 and Sense E2 for Lower arm .

Please use these terminals whenever measure spike voltage and on-state voltage.

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IGBT Modules

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